

INTRODUCTION

- 1. The contents is subject to change without notice. Please exchange the specification sheets regarding the product's warranty.
- 2. This sheet is not intended to guarantee or provide an approval of implementation of industrial patents.
- 3. We have prepared this sheet as carefully as possible. If you find it incomplete or unsatisfactory in any respect, We would welcome your comments.

This product is compliant with RoHS Directive.

This Product supplied (and any technical information furnished, if any) by Seiko Epson Corporation shall not be used for the development and manufacture of weapon of mass destruction or for other military purposes.

Making available such products and technology to any third party who may use such products or technologies for the said purposes are also prohibited.

This product listed here is designed as components or parts for electronics equipment in general consumer use.

We do not expect that any of these products would be incorporated or otherwise used as a component or part for the equipment, which requires an extra high reliability, such as satellite, rocket and other space systems, and medical equipment, the functional purpose of which is to keep life.

Product No. / Model The product No. of this crystal oscillator unit is X1G003931001300. The model is SG-210SCH.

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[1] Absolute maximum ratings

Parameter	Symbol	Value	Unit	Note
Supply voltage	Vcc-GND	-0.3 to +5.0	V	
Storage temperature *	T_stg	-40 to +125	°C	Stored as bare product after unpacking.
Input voltage	VIN	-0.3 to Vcc+0.3	V	ST Terminal

* Concerning the frequency change, please refer [8] Environmental and mechanical characteristics.

[2] Operating range

		Value				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage	Vcc	2.97	3.3	3.63	V	Vcc±10%
Supply voltage	GND	0.0	0.0	0.0	V	
Input voltage	VIN	GND	-	Vcc	V	
Operating temperature	T <u>use</u>	-40	+25	+85	°C	
Output load condition	L_CMOS	-	-	15	pF	

• Start up time(0 %Vcc \rightarrow 90 %Vcc) of power source should be more than 150 µs.

• By-pass capacitor (0.01 μF to 0.1 $\mu F)$ is connected near Vcc between Vcc and GND. (Refer to [12] Recommendable patterning)

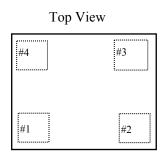
[3] Frequency characteristics

Output frequency (Fo) 150 MHz

Parameter	Symbol	Value $[1 \times 10^{-6}]$	Note
Frequency tolerance *	F_tol (OSC)	L: ± 50	T_use=-40 °C to +85 °C
Aging	F_aging	± 5	T_use=+25 °C, First year

* This includes initial frequency tolerance, temperature characteristics, input voltage characteristics, and load characteristics, aging , but excludes aging from $f_0=134$ MHz to 170MHz.

[4] Terminal assignment



Terminal name	Terminal No.	Terminal type.
ST	1	INPUT
GND	2	—
OUT	3	OUTPUT
Vcc	4	—

 $\overline{\text{ST}}$ pin : High. \rightarrow Specified frequency output = enable.

 \overline{ST} pin : Low. \rightarrow Output is high impedance = disabled.

[5] Electrical characteristics

(Please see page 2 [2] Operating range)

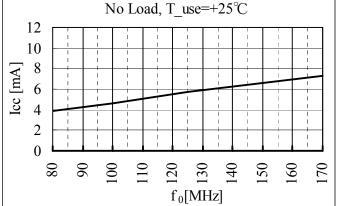
		Va	lue			
Parameter	Symbol	Min.	Max.	Unit	Note	
Start up time	t_str	-	5.0	ms	t=0 at 90 %VCC	
Current consumption	ICC	-	11.0	mA	No load	
Standby current	I_std	-	10	μΑ	ST =GND	
Output rise time *1	tr	-	2.0	ns	$20 \% \rightarrow 80 \% Vcc$	
Output fall time *1	tſ	-	2.0	ns	$80 \% \rightarrow 20 \% VCC$	
Symmetry	SYM	45	55	%	50 %Vcc Level	
High level output voltage	Voh	0.9Vcc	-	V	IOH = -4mA Vcc=1.62V	
Low level output voltage	Vol	-	0.1Vcc	V	IOL = 4mA Vcc=1.62V	
High level input voltage	VIH	0.8Vcc	-	V	ST terminal	
Low level input voltage	VIL	-	0.2Vcc	V	ST terminal	
Input current	IIH	-	50	μΑ	$V_{IN} = V_{CC}$	
	IIL	-50	-	μΑ	$V_{IN} = GND$	
Output disable time *2	tstp	-	100	ns	$\overline{\text{ST}}$ terminal High \rightarrow Low	
Output enable time *2	tsta	-	5.0	ms	$\overline{\text{ST}}$ terminal Low \rightarrow High	
Input pull-up resistance	D		150	kΩ	Vcc=3.3V, ST =0.8 Vcc, at +25 °C	
input pun-up resistance	R _{UP}	30	5	MΩ	Vcc=3.3V, ST =GND, at +25 °C	

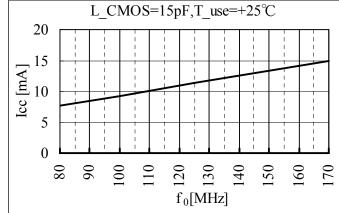
Refer to [6] Test circuit, [7] Timing chart

※1 [7] 1) C-MOS load

2 [7] 2) ST function and timing

• Reference : Current consumption Typ. Value (Vcc = 3.3 V, T_use = $+25 ^{\circ}$ C, No Load and L_CMOS=15pF)





Jitter Characteristic

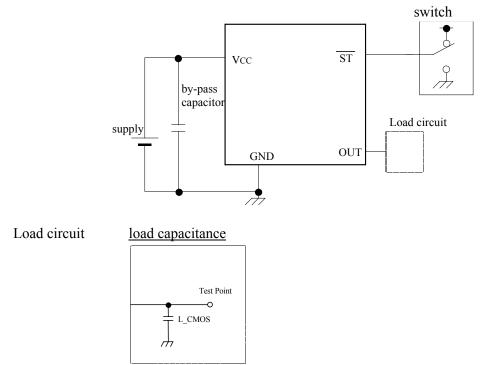
(Please see page 2 [2] Operating range)

a 1 1	Value				
Symbol	Тур.	Max.	Unit	Note	
tP-P	20	-	ps		
tpj	-	0.6	ps	Offset Frequency:12kHz~20MHz	
		SymbolTyp.tP-P20	SymbolTyp.Max.tP-P20-	SymbolTyp.Max.UnittP-P20-ps	

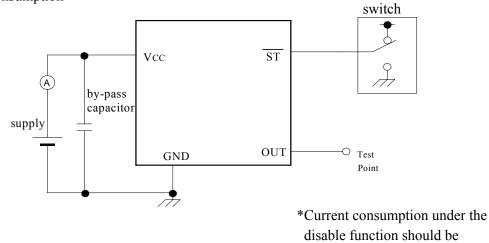
X1 WAVECREST Digital timing system SIA-3100C.

[6] Test circuit

1) Waveform observation

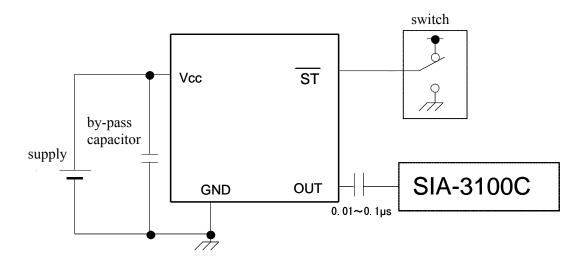


2) Current consumption



 $\overline{ST} = GND.$

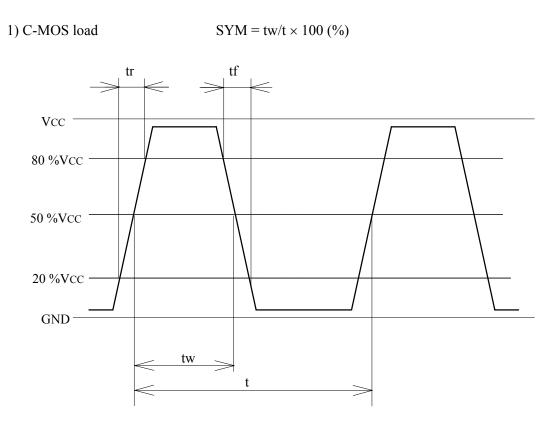
5



4) Condition

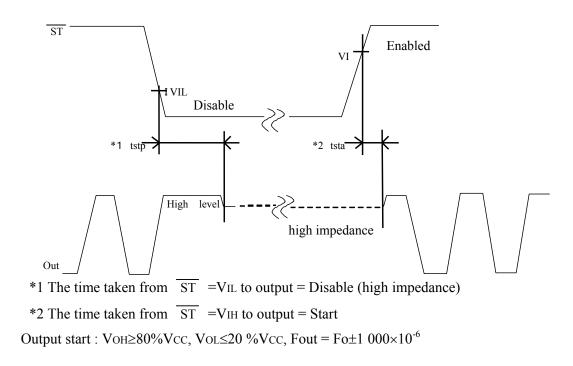
- (1) Oscilloscope
 - Band width should be minimum 5 times higher (wider) than measurement frequency.
 - Probe earth should be placed closely from test point and lead length should be as short as possible.
 - * Recommendable to use miniature socket. (Don't use earth lead.)
- (2) L_CMOS also includes probe capacitance.
- (3) By-pass capacitor (0.01 μ F to 0.1 μ F) is placed closely between Vcc and GND.
- (4) Use the current meter whose internal impedance value is small.
- (5) Power supply
 - Start up time (0 %Vcc \rightarrow 90 %Vcc) of power source should be more than 150 µs.
 - Impedance of power supply should be as lowest as possible.

[7] Timing chart



2) ST function and timing

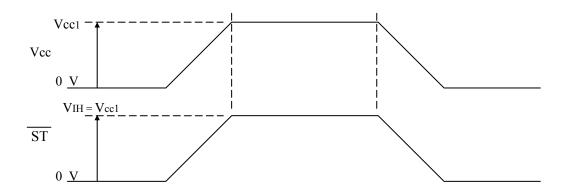
ST function	Osc. Circuit	Output status				
High	Oscillation	Specified frequency is output : Enable				
Low	Oscillation stop	Output becomes high impedance : Disable				



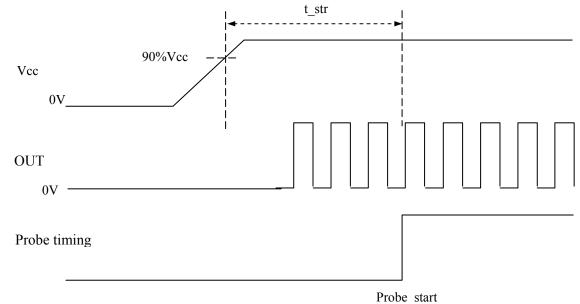
3) $\overline{\text{ST}}$ Control timing

- ST function is used on the voltage below supply voltage.
 - Vcc Vcc 0V $0.8Vcc1 \leq VIH \leq Vcc1$ \overline{ST} $0V \leq VIL \leq 0.2Vcc1$
 - ST control timing differs from Vcc control timing

ST terminal is connected to Vcc terminal



4) Timing of an output frequency signal



[8] Environmental and mechanical characteristics

		Valu	e *1	Test Conditions
No.	Item	$\Delta f / f^{*2}$ Electrical		
		$[1 \times 10^{-6}]$	characteristics	
1	High temperature storage	*3 ±20		+125 °C × 1 000 h
2	Low temperature storage	*3 ±10		-40 °C × 1 000 h
3	High temperature bias	*3 ±15		+85 °C × V_{CC} Max. × 1 000 h
4	Low temperature bias	*3 ±10		-40 °C × V_{CC} Max. × 1 000 h
5	Temperature humidity bias	*3 ±15		+85 °C × 85 %RH × V_{CC} Max. × 1 000 h
6	Temperature cycle	*3 ±20		$-40 \circ C \leftrightarrow +125 \circ C$
0		· 3 ± 20		30 min. at each temperature 100 cycles
7	Resistance to soldering heat	± 5		Convection reflow soldering furnace (3 times) Ref. IPC/JEDEC J-STD-020D.1
8	Shock	±6	Satisfy	Free drop from 750 mm height on a hard
0	SHOCK	<u> </u>	Item [5]	wooden board for 3 times
9	Vibration	±6		10 Hz to 55 Hz amplitude 0.75 mm 55 Hz to 500 Hz acceleration 98 m/s ² 10 Hz \rightarrow 500 Hz \rightarrow 10 Hz 15 min./cycle 6 h (2 hours , 3 directions)
10	Seal	1 × 10 ⁻⁹	$Pa \cdot m^3 / s$	He leak testing Ref. JIS/C60068-2-17
11	Solderability	Termination m		Dip termination into solder bath at
11	Soluciuonity	covered with f	resh solder	+235 °C \pm 5 °C for 5 s. (Using Rosin Flux)
12	Pull - off	No peeling-off at a solde		*
	I dii - Oli	part		Ref. EIAJ ED-4702

(The company evaluation condition We evaluate it by the following examination item and examination condition.)

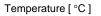
< Notes >

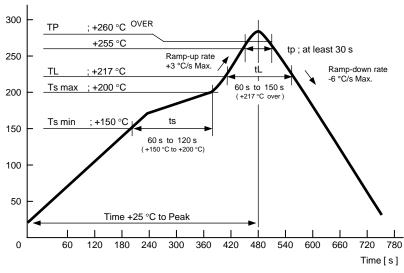
*1 Each test done independently.

*2 Measuring 2 h to 24 h later leaving in room temperature after each test.

*3 Initial value shall be measured after 24 h storage at room temperature after pre-conditioning. Pre-conditioning: Reflow (3 times)

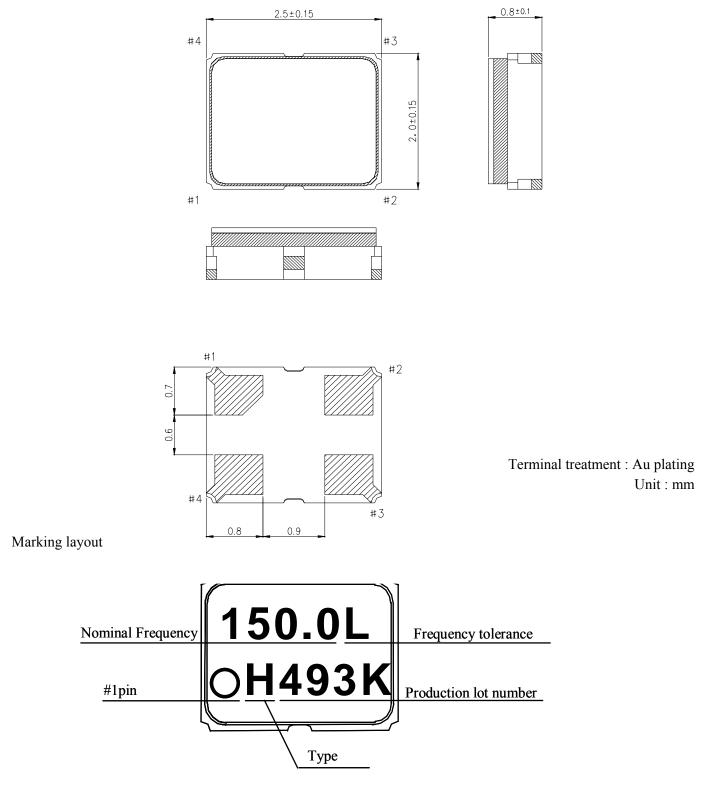
Convection reflow condition (Ref. IPC/JEDEC J-STD-020D.1)





[9] Dimensions and marking layout

1) Dimensions



- The above marking layout shows only marking contents and their approximate position and it is not for font, size and exact position.
- Output frequency shall indicate 5 digits (include decimal point), if the value of frequency over 5 digits, the least significant digits will be omitted.

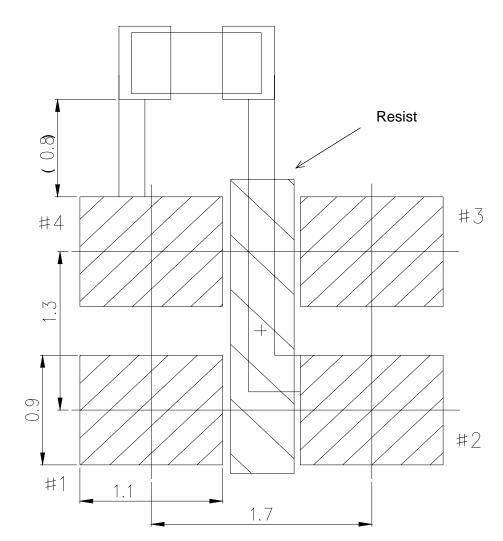
[10] Notes

- 1) This device is made with C-MOS IC. Please take necessary precautions to prevent damage due to electrical static discharge.
- 2) SEIKO EPSON recommends a 0.01 μ F to 0.1 μ F capacitor must be connected near Vcc between Vcc and GND to obtain stable operation and protect against power line ripple.
- 3) Vcc and GND pattern shall be as large as possible so that high frequency impedance shall be small.
- 4) SEIKO EPSON cannot recommend to put filtering element into power line so as to reduce noise. Oscillator might be unstable oscillation because high frequency impedance of power line become higher. When use filtering element, please verify electrical construction and or element's spec.
- 5) SEIKO EPSON doesn't recommend to power on from intermediate electric voltage or extreme fast power on, Those powering conditions may cause no oscillation or abnormal oscillation.
- 6) Power ripple: 200 mV _{P-P} max. Start up time (0 %Vcc→90 %Vcc) of power source should be more than 150 μs.
- 7) A long output line may cause irregular output, so try to make the output line as short as possible.
- 8) Other high-level signal lines may cause incorrect operation, so please do not place high level signal line close to this device.
- 9) This device contains a crystal resonator, so please don't expose excessive shock or vibration. SEIKO EPSON recommends store device under normal temperature and humidity to keep the specification.
- 10) An automatic insertion is available, however, the internal crystal resonator might be damaged in case that too much shock or vibration is applied by machine condition.Be sure to check your machine condition in advance.
- 11) Ultrasonic cleaning can be used on the SG-210SCH, however, since the oscillator might be damaged under some conditions, please exercise in advance.
- 12) SEIKO EPSON recommends to use and store under room temperature and normal humidity to secure frequency accuracy and prevent moisture.
- 13) ST -pin has pull-up resistor internally. The resistor value is switched depending on input voltage.
 Please refer to electrical characteristics. And if ST -pin is not controlled please connect it to Vcc-pin.
- 14) Lid is electrically connected to GND. Please don't apply electrical voltage.

[11] Recommendable patterning

The soldering pad sample indicated as like following:

Soldering position (Unit : mm)



C 0.01uF~0.1uF

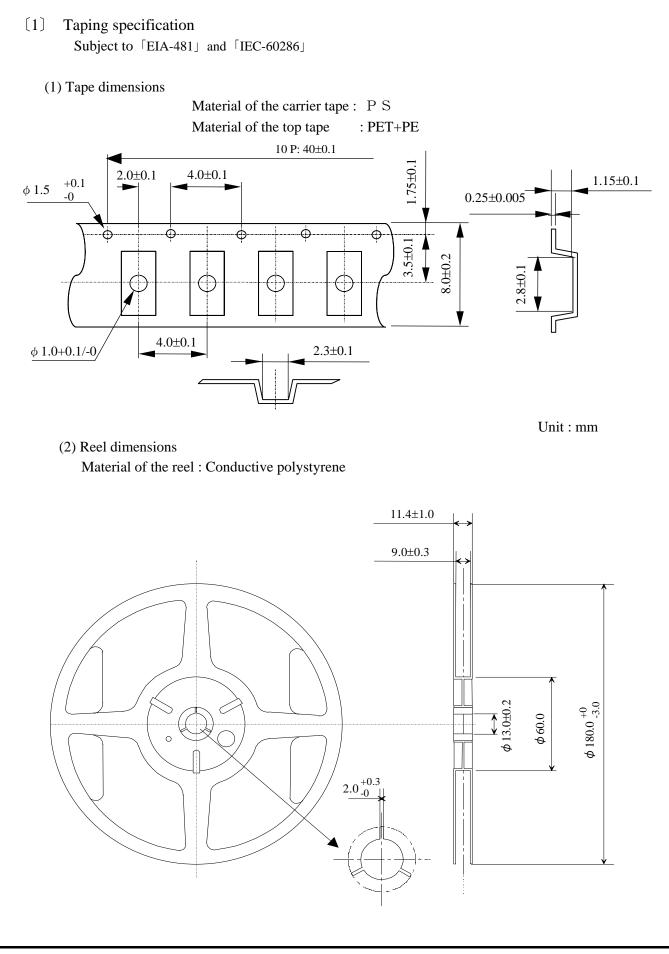
TAPING SPECIFICATION

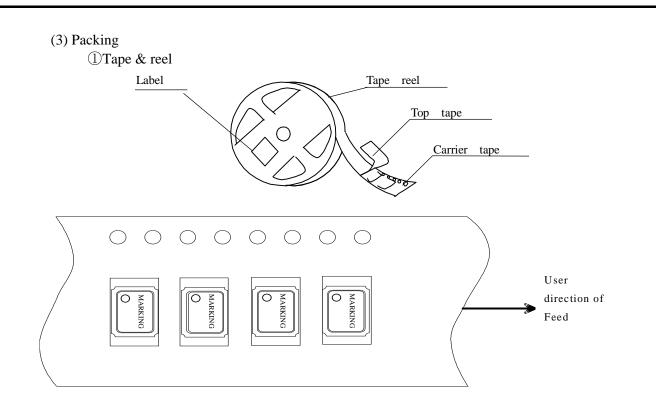
I. Application

This standard will apply to 2.5×2.0 Ceramic package. Spec : CG package

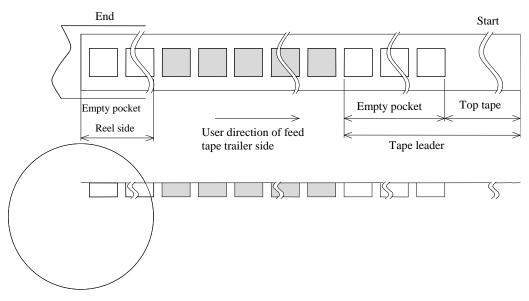
II. Contents

Item No.	Item	Page
[1]	Taping specification	1 to 2
[2]	Inner carton	3
[3]	Shipping carton	
[4]	Marking	4
[5]	Quantity	
[6]	Storage environment	
[7]	Handling	



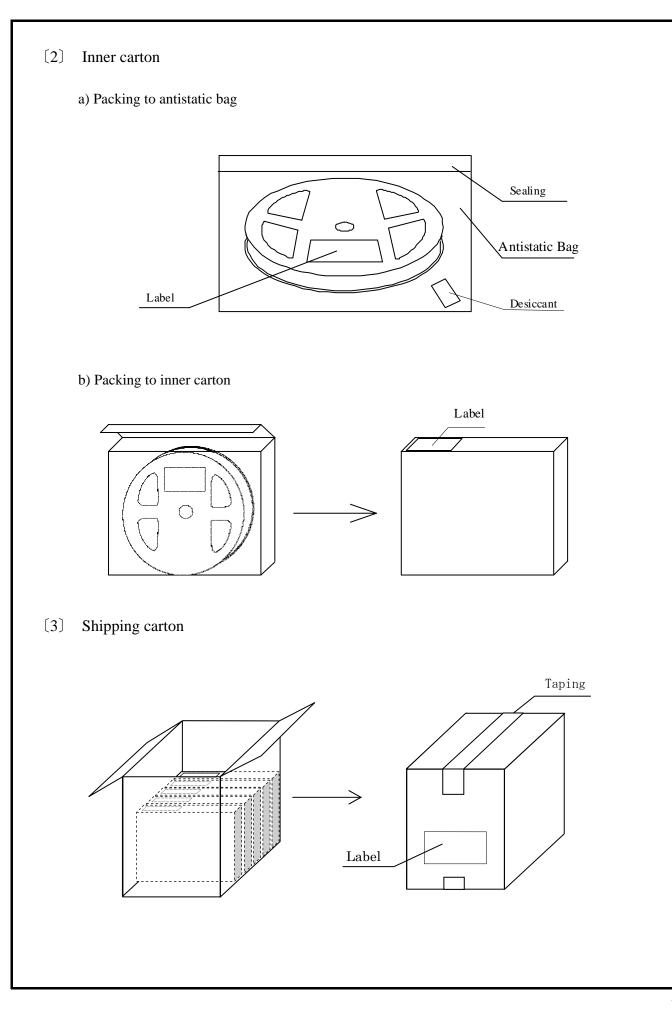


②Start & end point



Ite	Empty space		
Tape leader	Top tape	Min. 1 000 mm	
	Carrier tape	Min. 160 mm	
Tape trailer	Top tape	Min. 0 mm	
	Carrier tape	Min. 160 mm	

- (4) Peel force of the cover tape
 - ① angle : cover tape during peel off and the direction of unreeling shall be 165° to 180°.
 - 2 peel speed : 300 mm / min.



[4] Marking

- (1) Reel marking
 - Reel marking shall consist of :
 - 1) Parts name
 - 2) Quantity
 - 3) Manufacturing date or symbol
 - 4) Manufacturer's date or symbol
 - 5) Others (if necessary)
- (2) Inner carton marking
 - Same as reel marking.
- (3) Shipping carton marking
 - Shipping carton marking shall consist of :
 - 1) Parts name
 - 2) Quantity

[5] Quantity

• 3 000 pcs./reel

[6] Storage environment

- (1) Before open the packing, we recommend to keep less than +30 °C and 85 %RH of Humidity, and to use it less than 6 months after delivery.
- (2) We recommend to open Package in immediately before use. After open Package, We recommend to keeps less than 6 month. No need dry air before soldering work if it is less than temperature +30 °C, 85 humidity %RH.
- (3) Not to expose the sun.
- (4) Not to storage with some erosive chemicals.
- (5) Nothing is allowed to put on the reel or carton to prevent mechanical damage.

[7] Handling

• To handle with care to prevent the damage of tape, reel and products.

- PROCESS QUALITY CONTROL -

No. SG210S*H - 00 - ASE - 1 CRYSTAL OSCILLATOR : SG-210S*H

`12.06.22

Manufacturi	ing process chart	No.	Section In Charge	Standards	Inspection, Control Item	Instruments	Inspection Methods	Record
Lid Crystal IC H	Base	1	Inspection Section	Purchasing Specification Incoming Inspection Standard	Appearance Dimension	Microscope	Sampling	Data sheet
	1 Inspection	2	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance Peeling Strength	Microscope Scratch	Sampling	Data sheet
	3 Base Set	3	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
2 CHIP Set (4 Parts Mounting (IC)	4	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
	5 Wire Bonding	5	China Plant (Production Section)	Manufacturing Instruction Sheet	Bonding strength Appearance	Gauge Microscope	Sampling	Data sheet
(6 Crystal-Mounting	6	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sam;ling	Data sheet
(7 Annealing	7	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
(8 Frequency Adjusting (Crystal)	8	China Plant (Production Section)	Manufacturing Instruction Sheet	_	-	-	_
(9 Spot Sealing	9	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
(10 Hermetic Sealing	10	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance Frequency	Microscope Counter	Sampling	Data sheet
(11) High Temp Treatment	11	China Plant (Production Section)	Manufacturing Instruction Sheet	_	-	_	-
<	12 Leakage	12	China Plant (Production Section)	Manufacturing Instruction Sheet	Leakage Inspection	Measuring equipment	100% Inspection	Data sheet
(13 Marking	13	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Visual Inspection	Sampling	Data sheet
<	14 LDL Inspection	14	China Plant (Production Section)	Manufacturing Instruction Sheet	Characteristic Inspection	Measuring equipment	100% Inspection	Data sheet
<	15 Electrical Characteristic	15	China Plant (Production Section)	Manufacturing Instruction Sheet	Electrical Characteristic	Measuring equipment	100% Inspection	Data sheet
<	16 Temp Characteristic	16	China Plant (Production Section)	Manufacturing Instruction Sheet	Temp Characteristic Inspection	Measuring equipment	Sampling	Data sheet
F	17 Visual Inspection	17	China Plant (Production Section)	Manufacturing Instruction Sheet	Appearance	Microscope	Sampling	Data sheet
<	18 Outgoing Inspection	18	China Plant (Inspection Section)	Delivery Specifications Outgoing Inspection Standard	Electrical Characteristic Appearance	Measuring equipment Visual Inspection	Sampling	Data sheet
(19 Taping	19	Chaina Plant (Production Section)	Manufacturing Instruction Sheet	Tape peeling Strength Quantity Frequency check function	Peeling strength test machine	Sampling	Data sheet
(20) Packing	20	Chaina Plant (Production Control Section)	Manufacturing Instruction Sheet Daily Shipping List	Customers Type Quantity	-	-	Delivery Slip

